AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN

FREE



# Vishay General Semiconductor

# **Surface Mount Trench MOS Barrier Schottky Rectifiers**

## TMBS® eSMP® Series



Cathode O Anode

## **DESIGN SUPPORT TOOLS**

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PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	1.0 A		
$V_{RRM}$	45 V		
I <sub>FSM</sub>	30 A		
V <sub>F</sub> at I <sub>F</sub> = 1 A (T <sub>A</sub> = 125 °C)	0.36 V		
T <sub>J</sub> max.	150 °C		
Package	SMF (DO-219AB)		
Circuit configuration	Single		

#### **FEATURES**

- Trench MOS Schottky technology
- · Low profile package
- · Ideal for automated placement
- Low forward voltage drop, low power losses
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

## **MECHANICAL DATA**

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V1FL45	UNIT	
Device marking code		1LE		
Maximum repetitive peak reverse voltage	$V_{RRM}$	45	V	
Maximum average forward rectified current (fig.1)	I <sub>F(AV)</sub> (1)	1.0	Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30	А	
Operating junction temperature range	T <sub>J</sub> <sup>(2)</sup>	-40 to +150	°C	
Storage temperature range	T <sub>STG</sub>	-55 to +150	7	

### **Notes**

- $^{(1)}$  Free air, mounted on FR4 PCB, 2 oz. standard footprint
- $^{(2)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 0.5 A	- T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.41	-	- V
	I <sub>F</sub> = 1.0 A			0.45	0.53	
	I <sub>F</sub> = 0.5 A	- T <sub>A</sub> = 125 °C		0.30	-	
	I <sub>F</sub> = 1.0 A			0.36	0.44	
Reverse current	V <sub>R</sub> = 60 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	- I <sub>R</sub> <sup>(2)</sup>	-	0.25	- mA
	V <sub>R</sub> = 60 V			2.0	10	
Typical junction capacitance	4.0 V, 1 MHz		CJ	190	-	pF

### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °c unless otherwise noted)				
PARAMETER	SYMBOL	V1FL45	UNIT	
Typical thermal resistance	R <sub>0</sub> JA (1)(2)	125	°C/W	
	R <sub>0JM</sub> (2)	23	] 0/11	

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Device mounted on FR4 PCB, 2 oz. standard footprint, thermal resistance  $R_{\theta JA}$  – junction-to-ambient; thermal resistance  $R_{\theta JM}$  – junction-to-mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V1FL45-M3/H	0.015	Н	3000	7" diameter plastic tape and reel
V1FL45-M3/I	0.015	1	10 000	13" diameter plastic tape and reel
V1FL45HM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel
V1FL45HM3/I (1)	0.015	1	10 000	13" diameter plastic tape and reel

#### Note

(1) AEC-Q101 qualified



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# **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

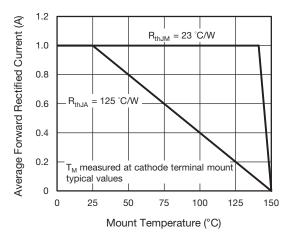


Fig. 1 - Maximum Forward Current Derating Curve

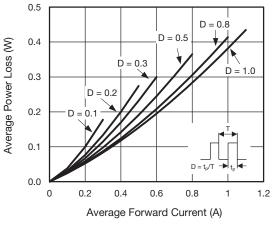


Fig. 2 - Average Power Loss Characteristics

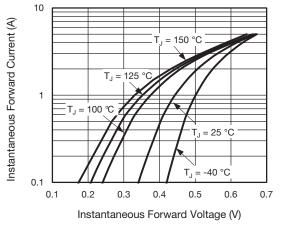


Fig. 3 - Typical Instantaneous Forward Characteristics

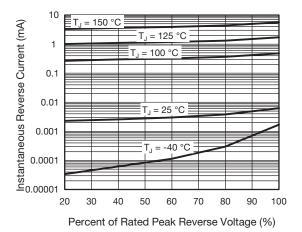


Fig. 4 - Typical Reverse Leakage Characteristics

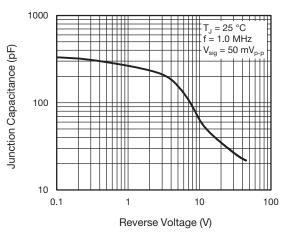


Fig. 5 - Typical Junction Capacitance

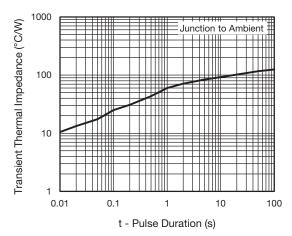
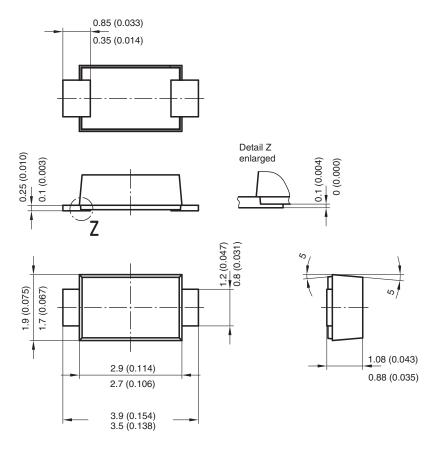


Fig. 6 - Typical Transient Thermal Impedance

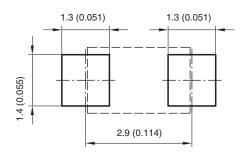


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## PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



### Foot print recommendation:



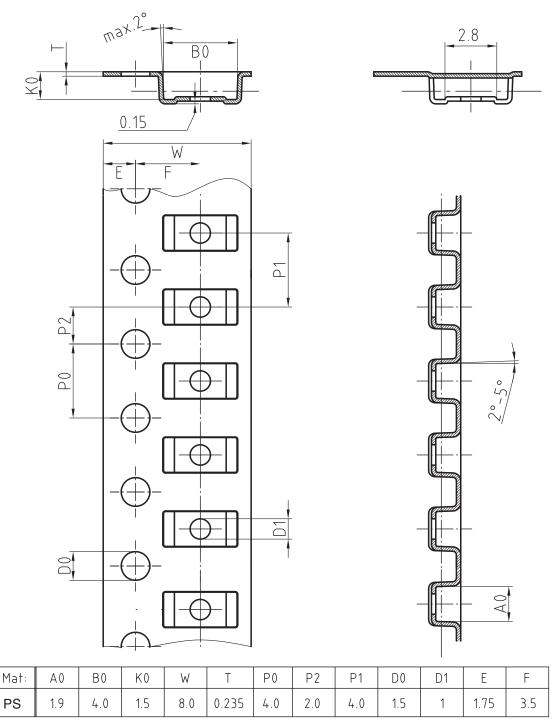
Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.:S8-V-3915.01-001 (4)

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# **BLISTERTAPE DIMENSIONS** in millimeters: **SMF (DO-219AB)**



Document-No.: S8-V-3717.02-001 (3)

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